

#### AMP .050 Series

TE Internal #: 5650181-2

Board-to-Board, 80 Position, 1.27 mm [.05 in] Centerline, 40 Dual

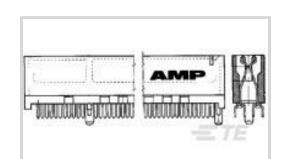
Positions, 2 Row, Brown, AMP .050 Series, Standard Edge

Connectors

View on TE.com >



Connectors > PCB Connectors > Card Edge Connectors > Standard Edge Connectors



Connector System: Board-to-Board

Number of Positions: 80

Centerline (Pitch): 1.27 mm [ .05 in ]

Number of Dual Positions: 40

Number of Rows: 2

### **Features**

#### **Electrical Characteristics**

| On a ratio of Valta are | 202 \/ \ C |  |
|-------------------------|------------|--|
| Operating Voltage       | 203 VAC    |  |

### **Termination Features**

| Termination Method to PCB      | Through Hole - Solder |
|--------------------------------|-----------------------|
| Termination Post & Tail Length | 3.56 mm[.14 in]       |

## Dimensions

| Card Slot Depth        | 7.62 mm[.3 in]                |
|------------------------|-------------------------------|
| Accepts Card Thickness | 1.37 – 1.78 mm[.054 – .07 in] |
| Connector Height       | 13.97 mm[.55 in]              |

### **Packaging Features**

| Packaging Quantity | 35  |
|--------------------|-----|
| Packaging Method   | Box |

#### **Mechanical Attachment**

| PCB Mount Retention      | With        |
|--------------------------|-------------|
| Mating Retention         | Without     |
| PCB Mount Retention Type | Boardlock   |
| Mating Alignment         | Without     |
| PCB Mount Alignment      | With        |
| Connector Mounting Type  | Board Mount |



### **Contact Features**

| Contact Underplating Material                           | Nickel           |
|---|------------------|
| PCB Contact Termination Area Plating Material Finish    | Bright           |
| Contact Mating Area Plating Material Thickness          | .76 μm           |
| PCB Contact Termination Area Plating Material Thickness | 2.54 μm[100 μin] |
| Contact Mating Area Plating Material                    | Gold             |
| Contact Base Material                                   | Phosphor Bronze  |
| PCB Contact Termination Area Plating Material           | Tin-Lead         |
| Contact Type  | Socket           |
| Contact Current Rating (Max)                            | 1 A              |
| Product Type Features                                   |                  |

| Connector System                  | Board-to-Board        |
|-----------------------------------|-----------------------|
| Connector & Housing Type          | Receptacle            |
| Connector & Contact Terminates To | Printed Circuit Board |

# **Configuration Features**

| Number of Positions              | 80           |
|----------------------------------|--------------|
| Number of Dual Positions         | 40           |
| Number of Rows                   | 2            |
| Connector Contact Load Condition | Fully Loaded |
| PCB Mount Orientation            | Vertical     |

# **Body Features**

| Primary Product Color | Brown |
|-----------------------|-------|
|-----------------------|-------|

# **Housing Features**

| Centerline (Pitch) | 1.27 mm[.05 in]                |
|--------------------|--------------------------------|
| Housing Material   | High Temperature Thermoplastic |

# **Usage Conditions**

| Operating Temperature Range -55 – 85 °C[-67 – 185 °F] |
|---|
|---|

# Operation/Application

| Circuit Application | Signal |
|---------------------|--------|
|---------------------|--------|

### Other

| EU RoHS Compliance | Compliant |
|--------------------|-----------|
| EU ELV Compliance  | Compliant |



### **Product Compliance**

For compliance documentation, visit the product page on TE.com>

| EU RoHS Directive 2011/65/EU                  | Compliant   |
|---|---|
| EU ELV Directive 2000/53/EC                   | Compliant   |
| China RoHS 2 Directive MIIT Order No 32, 2016 | No Restricted Materials Above Threshold   |
| EU REACH Regulation (EC) No. 1907/2006        | Current ECHA Candidate List: JUNE 2024 (241) Candidate List Declared Against: JUNE 2024 (241) Does not contain REACH SVHC |
| Halogen Content                               | Not Low Halogen - contains Br or Cl > 900 ppm.  |
| Solder Process Capability                     | Wave solder capable to 265°C  |

#### Product Compliance Disclaimer

This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information they provided. This information is subject to change. The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, mercury, PBB, PBDE, DBP, BBP, DEHP, DIBP, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2011/65/EU (RoHS2). Finished electrical and electronic equipment products will be CE marked as required by Directive 2011/65/EU. Components may not be CE marked. Additionally, the part numbers that TE has identified as EU ELV compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, and mercury, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2000/53/EC (ELV). Regarding the REACH Regulation, the information TE provides on SVHC in articles for this part number is based on the latest European Chemicals Agency (ECHA) 'Guidance on requirements for substances in articles' posted at this URL: https://echa.europa.eu/guidance-documents/guidance-on-reach

# **Compatible Parts**

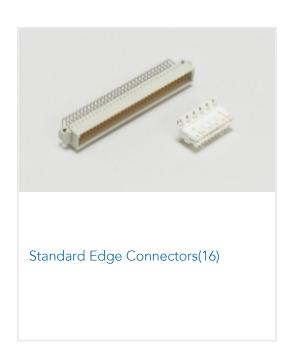






Also in the Series | AMP .050 Series





# Customers Also Bought



### **Documents**

## **Product Drawings**

STANDARD EDGE .050 SERIES 40 DUAL ASSY

English

### **CAD Files**

**Customer View Model** 

ENG\_CVM\_CVM\_5650181-2\_A.2d\_dxf.zip

English

3D PDF

3D

**Customer View Model** 

ENG\_CVM\_CVM\_5650181-2\_A.3d\_igs.zip

English

**Customer View Model** 

ENG\_CVM\_CVM\_5650181-2\_A.3d\_stp.zip

English

By downloading the CAD file I accept and agree to the **Terms and Conditions** of use.

# **Product Specifications**

**Application Specification** 

English